

Fabrication Processes

Provided are processes for fabricating different devices:

[General Solvent Clean SOP for wafers and slides](#)

[PDMS Device Fabrication](#)

[COC Device Fabrication](#)

[Plasma treatment for PDMS bonding](#)

[Solvent Cleaning SOP for Microfluidic Devices](#)

[Dip Coating HCl](#)

[Making 3D printed Molds](#)

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